

3A Fixed Output Voltage LDO Regulator

General Description

The RT9172 series of low-dropout linear regulators operate from a +2.25V to +6.0V input supply. A wide range of preset output voltage options is available. These low dropout linear regulators respond very fast to step changes in load, which are suitable for low voltage microprocessor applications. The RT9172 uses an internal PMOS as the pass device, which does not cause extra GND current in heavy load and dropout condition. The shutdown mode of low operation current makes the IC suitable for power-saving systems. The other features include current limiting and over temperature protection.

Ordering Information

| | | | | | | | |
|-----------------------------|---|---------------------|---|---|---|---|--|
| RT9172 | - | □ | □ | □ | □ | □ | |
| Package type | | | | | | | |
| T5 | : | TO-220-5 | | | | | |
| M5 | : | TO-263-5 | | | | | |
| T | : | TO-220 | | | | | |
| M | : | TO-263 | | | | | |
| G | : | SOT-223 | | | | | |
| S | : | SOP-8 | | | | | |
| Operating temperature range | | | | | | | |
| C | : | Commercial standard | | | | | |
| Output voltage | | | | | | | |
| 15 | : | 1.5V | | | | | |
| 16 | : | 1.6V | | | | | |
| : | | | | | | | |
| 32 | : | 3.2V | | | | | |
| 33 | : | 3.3V | | | | | |
| S : Pin out exchange | | | | | | | |
| N | : | Pin 5 bond "SENSE" | | | | | |
| F | : | Pin 5 bond "FLG" | | | | | |

Features

- Low Dropout Voltage
- Low Ground Pin Current
- Load Regulation of 0.4% at 3A
- 0.5µA Quiescent Current in Shutdown Mode
- Guaranteed Output Current of 3A DC
- Available in TO-263 and TO-220 Packages
- Output Voltage Accuracy ±1.5%
- Error Flag Indicates Output Status
- Sense Option Improves Better Load Regulation
- Extremely Low Output Capacitor Requirements
- Over-temperature/Over-current Protection

Applications

- Microprocessor Power Supplies
- GTL, GTL+, BTL, and SSTL Bus Terminators
- Power Supplies for DSPs
- SCSI Terminator
- Post Regulators
- High Efficiency Linear Regulators
- Battery Chargers
- Other Battery Powered Applications

Pin Configurations

| Part Number | Pin Configurations | |
|----------------------------------|--------------------|---|
| RT9172-□□CT (Plastic TO-220) | | TOP VIEW 1. VIN 2. GND (TAB) 3. VOUT |
| RT9172-□□CM (Plastic TO-263) | | TOP VIEW 1. VIN 2. GND (TAB) 3. VOUT |
| RT9172-□□CG (Plastic SOT-223) | | TOP VIEW 1. VIN 2. GND (TAB) 3. VOUT |

To be continued

| Part Number | Pin Configurations | Part Number | Pin Configurations |
|--|--|-------------------------------------|---|
| RT9172N-□□CT5 RT9172F-□□CT5 (Plastic TO-220-5) | <p>TOP VIEW 1. EN 2. VIN 3. GND (TAB) 4. VOUT 5. SENSE/FLG</p> | RT9172S-□□CT5 (Plastic TO-220-5) | <p>TOP VIEW 1. VIN 2. EN 3. GND (TAB) 4. SENSE 5. VOUT</p> |
| RT9172N-□□CM5 RT9172F-□□CM5 (Plastic TO-263-5) | <p>TOP VIEW 1. EN 2. VIN 3. GND (TAB) 4. VOUT 5. SENSE/FLG</p> | RT9172S-□□CM5 (Plastic TO-263-5) | <p>TOP VIEW 1. VIN 2. EN 3. GND (TAB) 4. SENSE 5. VOUT</p> |
| RT9172-□□CS (Plastic SOP-8) | <p>TOP VIEW 1. VOUT 2. SENSE 3. GND 4. NC 5. EN 6. GND 7. GND 8. VIN</p> | | |

Pin Description

| Pin No. | | | | Pin Name | Pin Function |
|---------|---------|---------|--|----------|----------------|
| RT9172F | RT9172N | RT9172S | RT9172- □□CT RT9172- □□CM RT9172- □□CG | | |
| 1 | 1 | 2 | -- | EN | Chip Enable |
| 2 | 2 | 1 | 1 | VIN | Power Input |
| 3 | 3 | 3 | 2 | GND | Ground |
| 4 | 4 | 5 | 3 | VOUT | Output Voltage |
| 5 | -- | -- | -- | FLG | ERROR Flag |
| -- | 5 | 4 | -- | SENSE | Remote Sense |

Typical Application Circuit

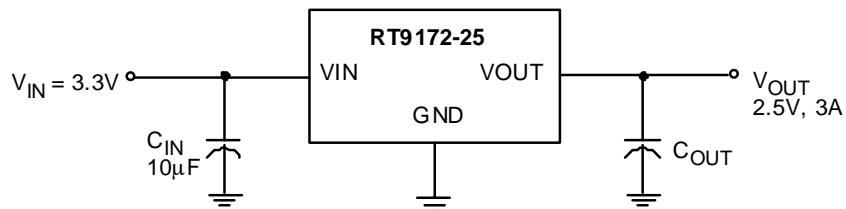


Fig. 1

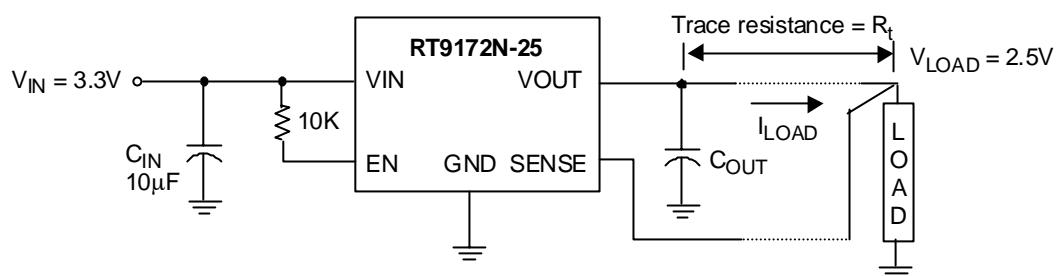


Fig. 2

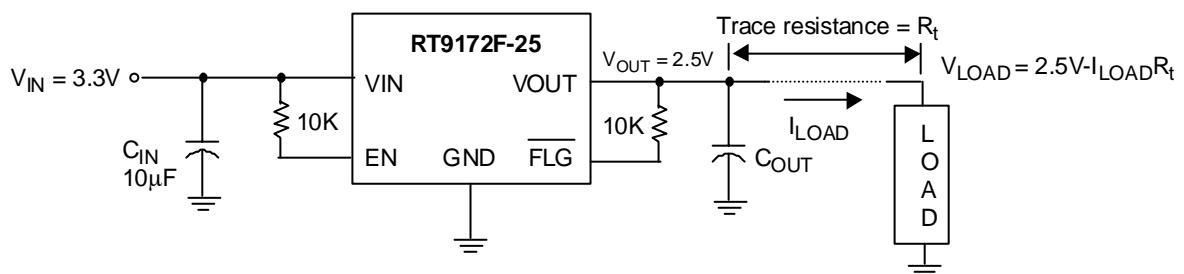
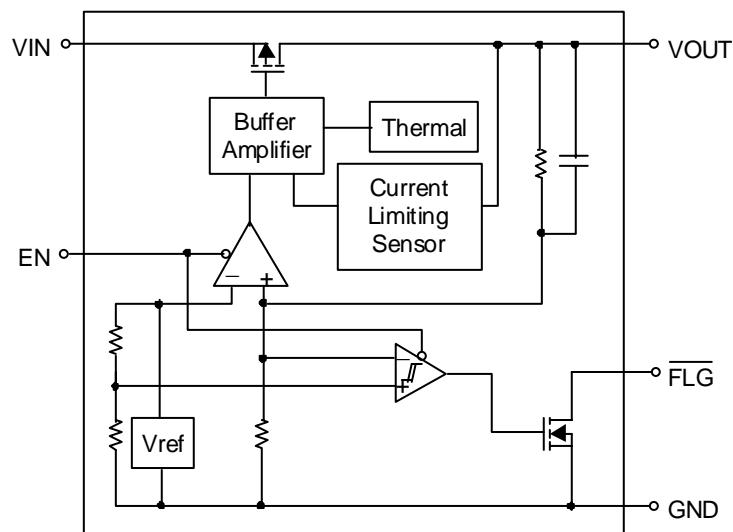


Fig. 3

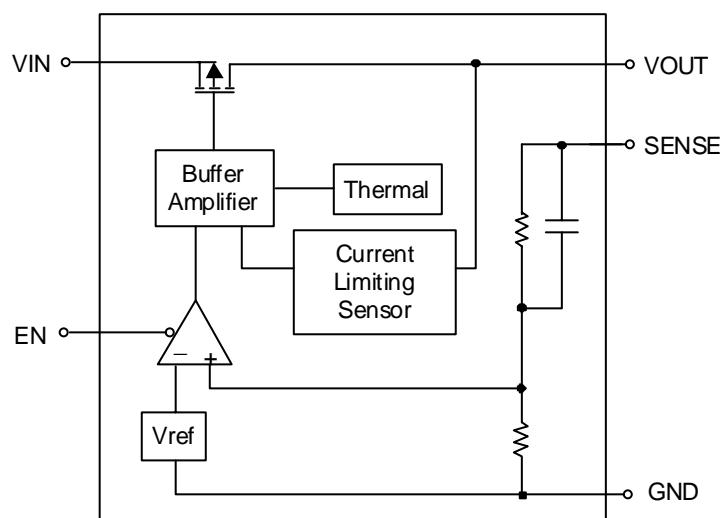
Recommend C_{OUT} : Please note that the part must be paralleled with the least a $100\mu F$ electrolytic capacitor when using a $10\mu F$ (or greater) ceramic type as the output capacitor to prevent the output oscillating.

Function Block Diagram

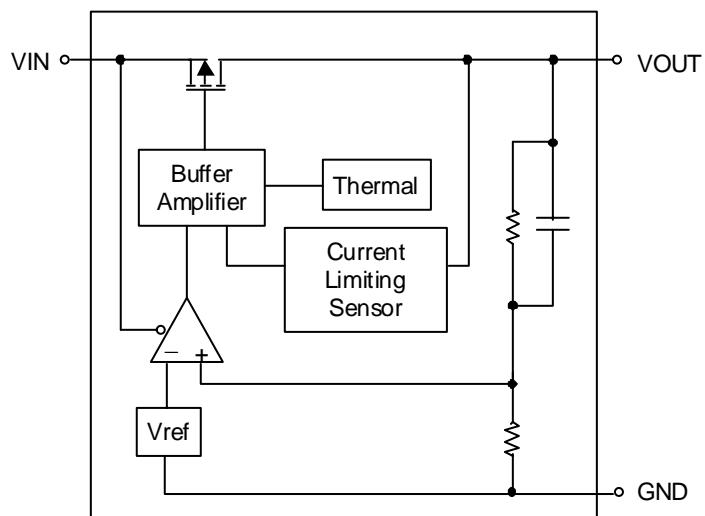
RT9172F



RT9172N/RT9172S



RT9172



Absolute Maximum Ratings

| | | |
|--|-------|--------------------|
| • Input Voltage | ----- | 6V |
| • Power Dissipation | ----- | Internally Limited |
| • ESD Rating | ----- | 3 kV |
| • Storage Temperature Range | ----- | -65°C to 150°C |
| • Lead Temperature (Soldering, 5 sec.) | ----- | 260°C |
| • Package Thermal Resistance | ----- | ----- |
| TO-263, θ_{JC} | ----- | 8°C/W |
| TO-263, θ_{JA} | ----- | 19.4°C/W |
| TO-220, θ_{JC} | ----- | 8°C/W |
| TO-220, θ_{JA} | ----- | 62°C/W |
| SOT-223, θ_{JC} | ----- | 15°C/W |
| SOT-223, θ_{JA} | ----- | 60°C/W |
| SOP-8, θ_{JA} | ----- | 160°C/W |
| • Junction Temperature Range | ----- | -40°C to +125°C |

Electrical Characteristics

(Limits in standard typeface are for $T_A = 25^\circ\text{C}$, unless otherwise specified: $V_{IN} = V_O(\text{NOM}) + 1.0\text{V}$, $I_L = 10\text{mA}$, $C_{OUT} = 10\mu\text{F}$ (Electrolytic), $V_{EN} = V_{IN}$)

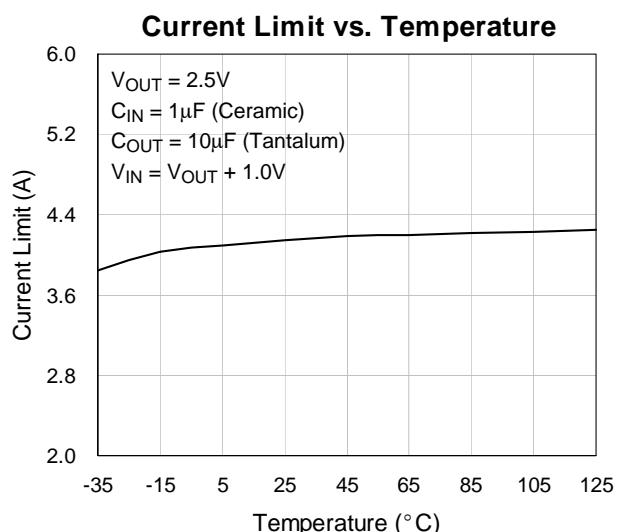
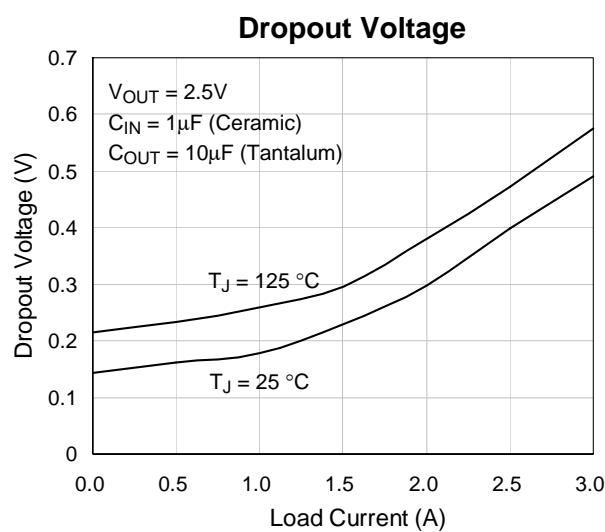
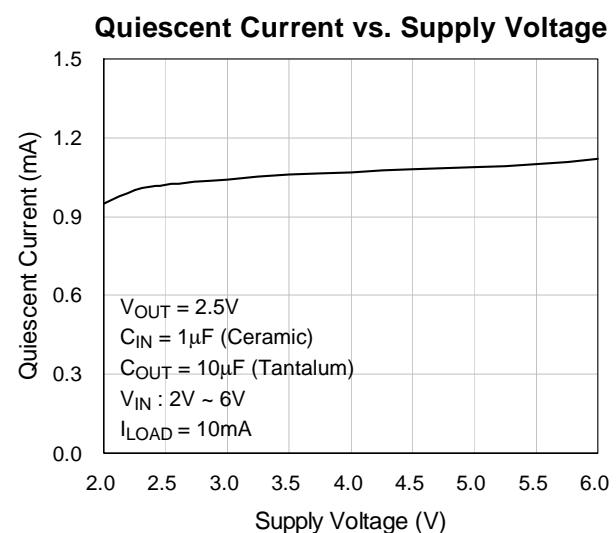
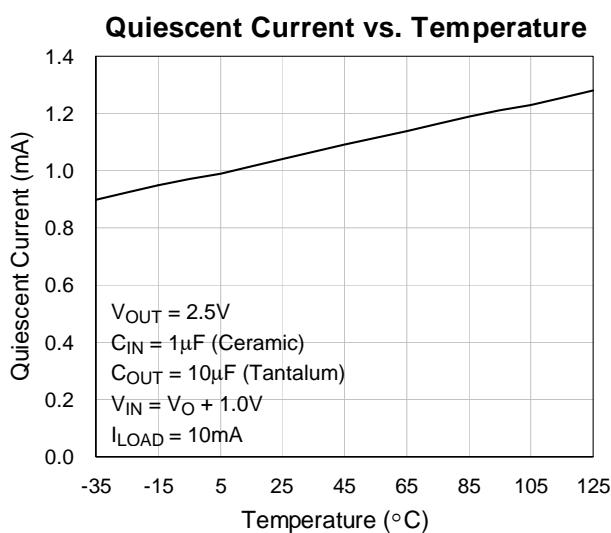
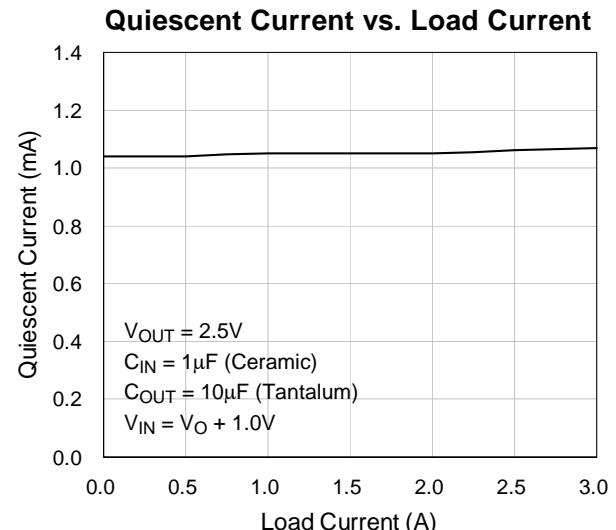
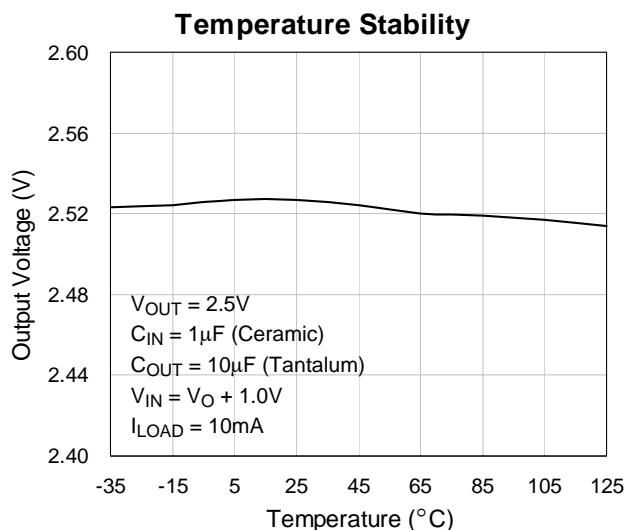
| Parameter | Symbol | Test Conditions | Min | Typ | Max | Units |
|------------------------------------|--------------------|--|------|----------|------|------------------|
| Output Voltage Tolerance | | | -1.5 | 0 | +1.5 | % |
| Input Voltage Range | V_{IN} | | 2.25 | -- | 5.5 | V |
| Line Regulation | ΔV_{LINE} | $V_{OUT} + 0.4\text{V} < V_{IN} < 5.5\text{V}$ | -- | 0.35 | 1 | % |
| Load Regulation | ΔV_{LOAD} | Note 1 | -- | 0.4 | 1 | % % |
| | | Note 2 | -- | 0.1 | 0.4 | |
| | | Note 3 | -- | 0.1 | 0.4 | |
| Dropout Voltage | V_{DROP} | $I_L = 3\text{A}$ | -- | 400 | 700 | mV |
| Quiescent Current | I_Q | | -- | 1.2 | 3 | mA |
| Shutdown Supply Current | I_{GSD} | $V_{EN} = 0\text{V}$ | -- | 0.5 | 5 | μA |
| Peak Output Current | $I_O(\text{PEAK})$ | | 3.5 | 5 | -- | A |
| Short Circuit Protection | | | | | | |
| Current Limit | I_{LIMIT} | | 3.5 | 5 | -- | A |
| Over Temperature Protection | | | | | | |
| Shutdown Threshold | T_{SD} | Guaranteed by design | -- | 170 | -- | $^\circ\text{C}$ |
| Thermal Shutdown Hysteresis | | Guaranteed by design | -- | 10 | -- | $^\circ\text{C}$ |
| Shutdown Function | | | | | | |
| EN Pin Shutdown Threshold | V_{EN} | Output = High | 1.2 | V_{IN} | -- | V |
| | | Output = Low | -- | 0 | 0.4 | |
| EN Input Current | | $V_{EN} = V_{IN}$ | -- | 0.1 | -- | nA |
| FLG Pin Leakage Current | $I_{LEAKAGE}$ | | -- | 1 | -- | nA |
| FLG Pin Sink Current | | $V_{FLG} = 0.5\text{V}$ | 2 | -- | -- | mA |

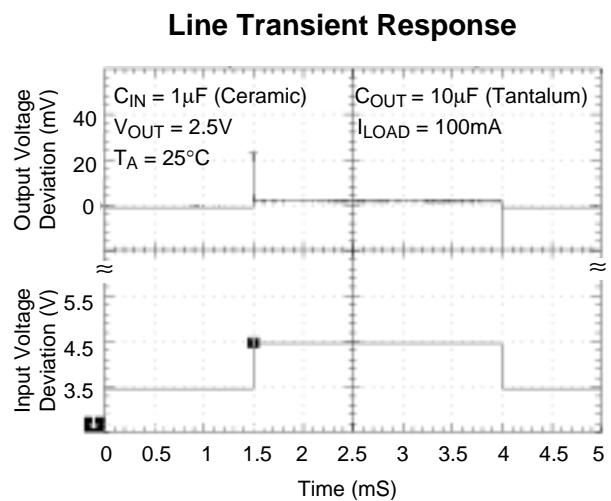
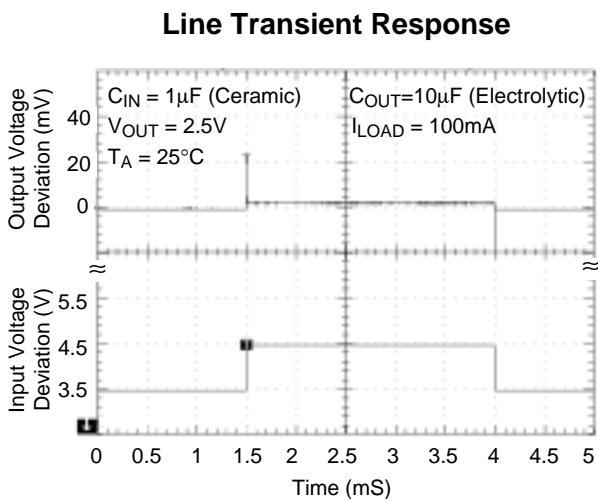
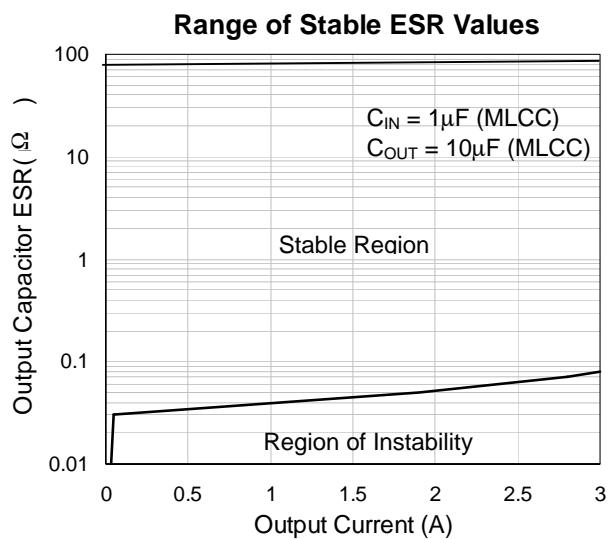
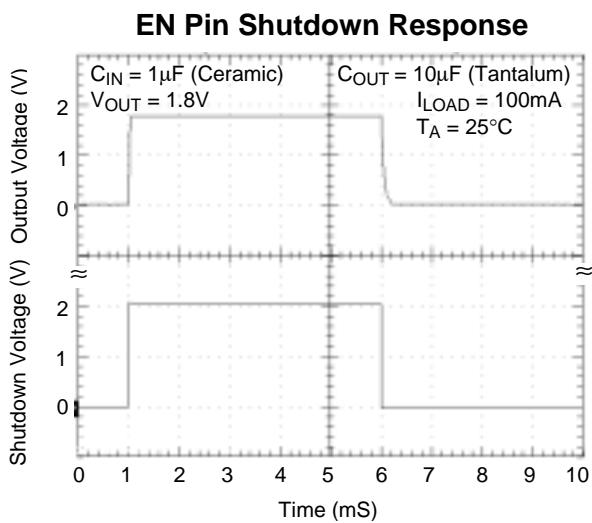
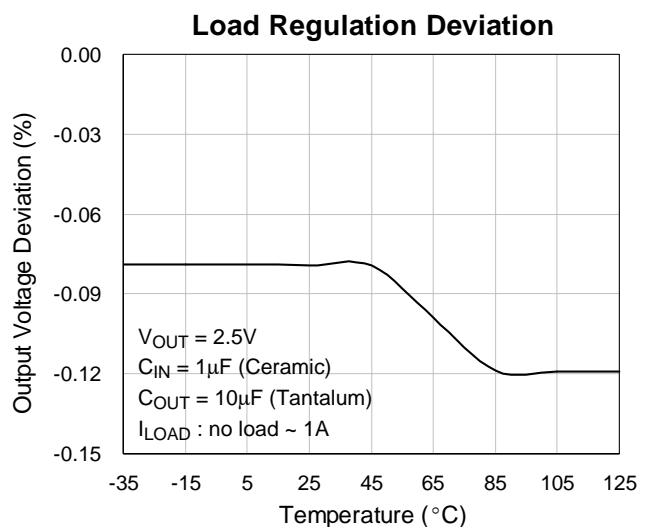
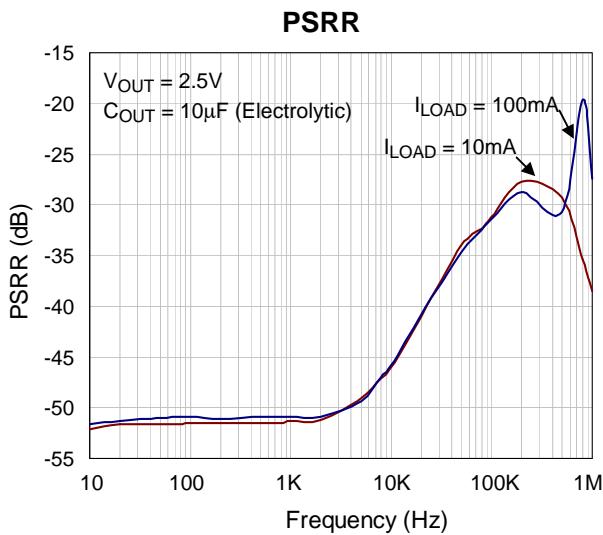
Note 1: RT9172-CX, RT9172F-XXCX5, $10\text{mA} < I_L < 3\text{A}$

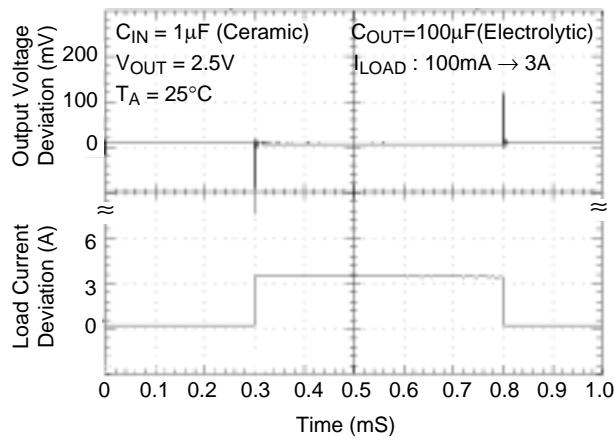
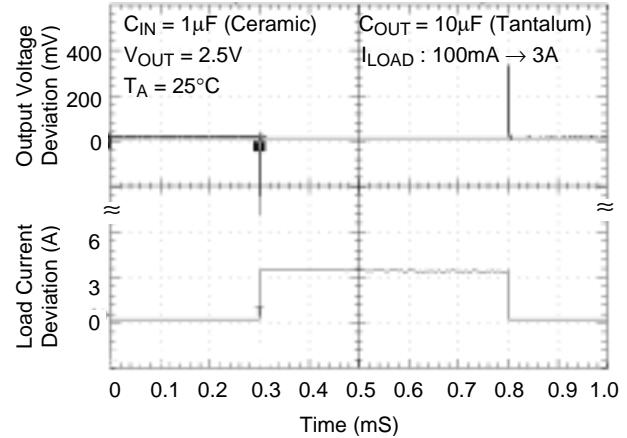
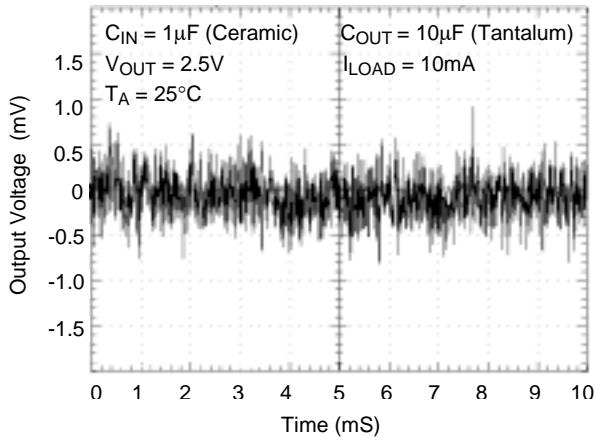
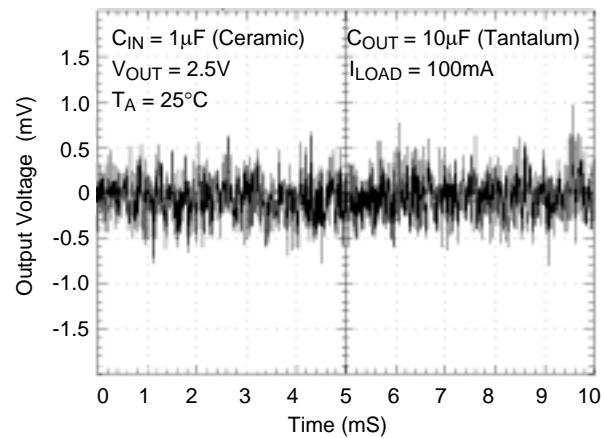
Note 2: RT9172S-XXCX5, RT9172N-XXCX5, $10\text{mA} < I_L < 3\text{A}$

Note 3: RT9172CS, $10\text{mA} < I_L < 1.5\text{A}$

Typical Operating Characteristics





Load Transient Response**Load Transient Response****Noise Signal****Noise Signal**

Functional Description

Capacitor Selection

- An output capacitor as part of the device frequency compensation to maintain stability and improve transient response.
- Proper capacitor selection is important to ensure proper operation. When the output capacitor is $10\mu F$ or greater, the output capacitor should have an ESR less than 2Ω . This will improve transient response as well as promote stability.
- Ultra-low-ESR capacitor ($<100m\Omega$), such as ceramic chip capacitors, may promote instability. These very low ESR levels may cause an oscillation and/or underdamped transient response. A low-ESR solid tantalum capacitor works extremely well and provides good transient response and stability over temperature. Aluminum electrolytics can also be used, as long as the ESR of the capacitor is $<2\Omega$. The value of the output capacitor can be increased without limit. Higher capacitor values help to improve transient response and ripple rejection and reduce output noise.

The RT9172 requires a minimum input capacitance of $1\mu F$ between the input and ground pins to prevent any impedance interactions with the supply. The RT9172 requires a minimum of $10\mu F$ (tantalum, or electrolytic) capacitance between the output and ground pins for proper operation. Please note that the part must be paralleled with the least a $100\mu F$ electrolytic capacitor when using a $10\mu F$ (or greater) ceramic type as the output capacitor to prevent the output oscillating.

Error Operation (FLG)

The RT9172 produces a logic low signal at the FLG pin when the output drops out of regulation due to low input voltage, current limiting, or thermal limiting.

The internal error FLG comparator has an open drain output stage. Hence, the FLG pin should be pulled high through a pull up resistor.

Sense Pin

In applications where the regulator output is not very close to the load, RT9172 can provide better remote load regulation using the SENSE pin. Fig.2 and Fig.3 depict the advantage of the SENSE option. RT9172 regulates the voltage at the output pin. Hence, the voltage at the remote load will be the regulator output voltage minus the drop across the trace resistance. For example, in the case of a 3.3V output, if the trace resistance is $100m\Omega$, the voltage at the remote load will be 3V with 3A of load current, I_{LOAD} . The RT9172 regulates the voltage at the sense pin. Connecting the sense pin to the remote load will provide regulation at the remote load, as shown in Fig.2 and Fig.3.

Chip Enable Operation

A CMOS logic level signal at the chip enable (EN) pin will turn-off the regulator. Pin EN must be actively terminated through a $10k\Omega$ pull-up resistor for a proper operation. If this pin is driven from a source that actively pulls high and low (such as a CMOS rail to rail comparator), the pull-up resistor is not required. This pin must be tied to V_{IN} if not used.

Dropout Voltage

The dropout voltage of a regulator is defined as the minimum input-to-output differential required to stay within 2% of the output voltage. The RT9172 uses an internal MOSFET with an $R_{DS(ON)}$ $160m\Omega$. For CMOS LDOs, the dropout voltage is the product of the load current and the $R_{DS(ON)}$ of the internal MOSFET.

Maximum Output Current Capability

RT9172 can deliver a continuous current of 1.5 A over the full operating temperature range. A heatsink may be required depending on the maximum power dissipation and maximum ambient temperature of the application. Under all possible conditions, the junction temperature must be within the range specified under operating conditions. The total power dissipation of the device is given by:

$$PD = (V_{IN} - V_{OUT}) I_{OUT} + (V_{IN}) I_{GND}$$

where I_{GND} is the operating ground current of the device (specified under Electrical Characteristics).

The maximum allowable temperature rise (T_{RMAX}) depends on the maximum ambient temperature (T_{AMAX}) of the application, and the maximum allowable junction temperature (T_{JMAX}):

$$T_{RMAX} = T_{JMAX} - T_{AMAX}$$

The maximum allowable value for junction to ambient Thermal Resistance, θ_{JA} = $T_{RMAX} - T_{AMAX}$

The maximum allowable value for junction to ambient Thermal Resistance, θ_{JA} , can be calculated using the formula:

$$\theta_{JA} = T_{RMAX} / P_D$$

RT9172 are available in TO-220, TO-263, and SOT-223 packages. The thermal resistance depends in amount of copper area or heat sink, and on air flow. If the maximum allowable value of θ_{JA} calculated above is 60 °C/W for TO-220 package, 60 °C/W for TO-263 package, and 140 °C/W for SOT-223 package, no heatsink is needed since the package can dissipate enough heat to satisfy these requirements. If the value for allowable θ_{JA} falls below these limits, a heat sink is required.

Heatsinking TO-220 Packages

The thermal resistance of a TO-220 package can be reduced by attaching it to a heat sink or a copper plane on a PC board. If a copper plane is to be used, the values of θ_{JA} will be same as shown in next section for TO-263 package.

Heatsinking TO-263 and SOT-223 Packages

The TO-263 and SOT-223 packages use the copper plane on the PCB as a heatsink. The tab of these packages are soldered to the copper plane for heat sinking. Fig.4 shows a curve for θ_{JA} of TO-263 package for different copper area sizes, using a typical PCB with 1 ounce copper and no solder mask over the copper area for heat sinking.

As shown in the figure, increasing the copper area beyond 1 square inch produces very little improvement. The minimum value for θ_{JA} for the TO-263 package mounted to a PCB is 32°C/W.

θ_{JA} vs. Copper (1 Ounce) Area for TO-263

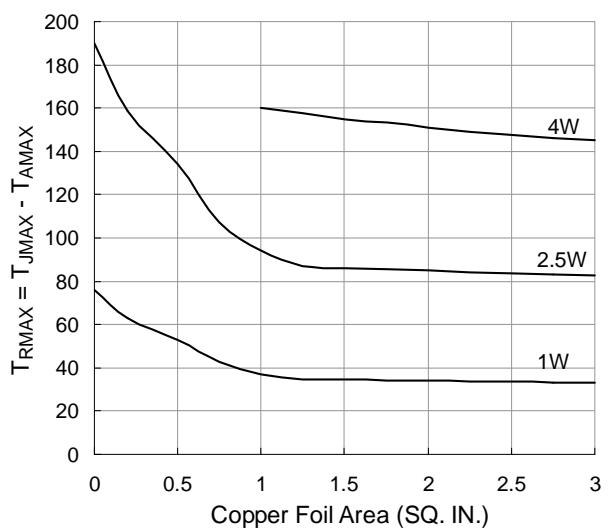
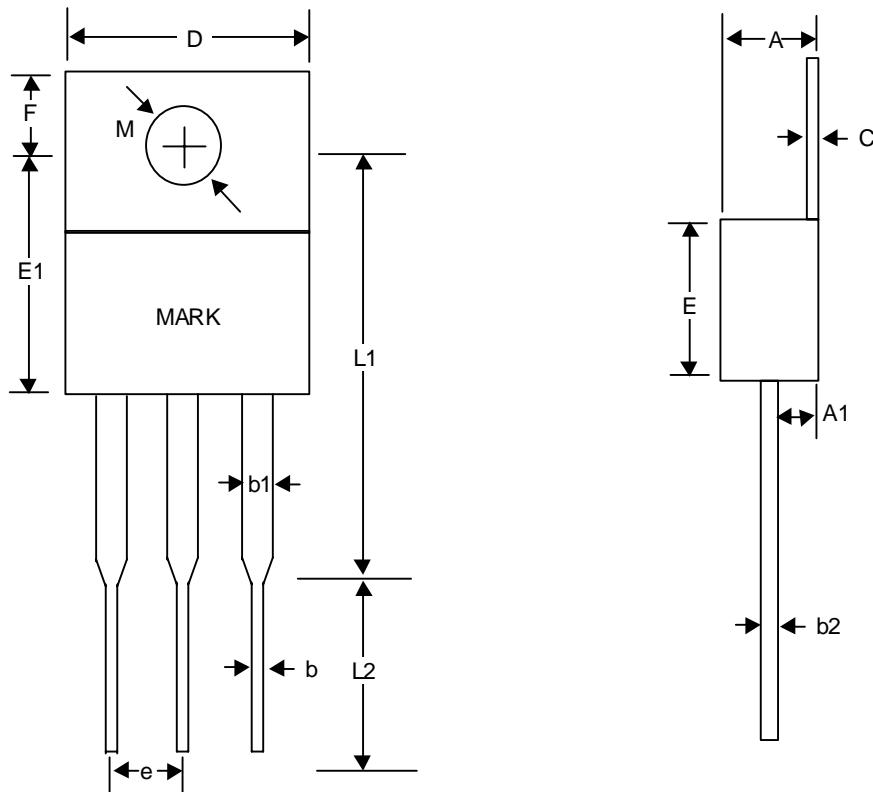


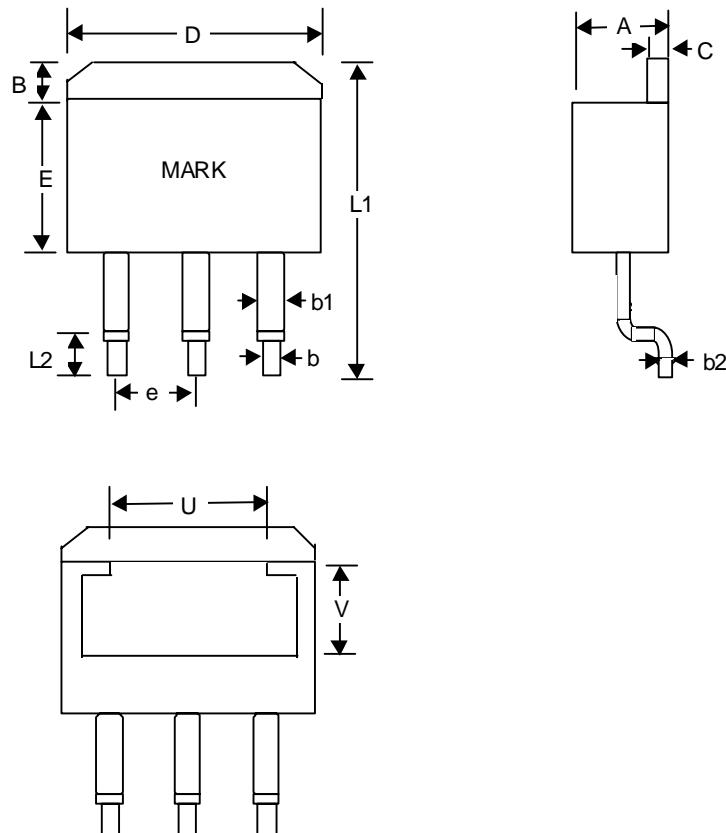
Fig. 4

Package Information



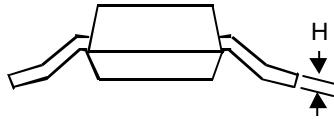
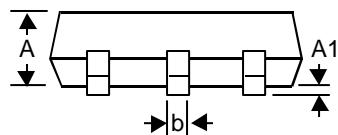
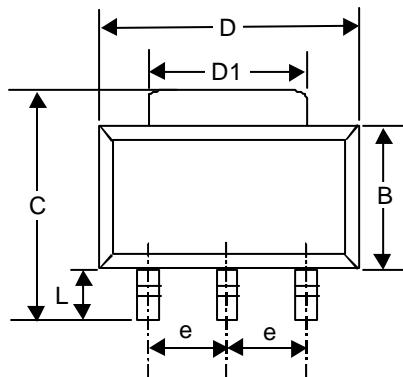
| Symbol | Dimensions In Millimeters | | Dimensions In Inches | |
|--------|---------------------------|--------|----------------------|-------|
| | Min | Max | Min | Max |
| A | 4.064 | 4.826 | 0.160 | 0.190 |
| A1 | 2.032 | 2.921 | 0.080 | 0.115 |
| b | 0.635 | 1.016 | 0.025 | 0.040 |
| b1 | 1.143 | 1.524 | 0.045 | 0.060 |
| b2 | 0.305 | 0.559 | 0.012 | 0.022 |
| C | 1.143 | 1.397 | 0.045 | 0.055 |
| D | 9.779 | 10.668 | 0.385 | 0.420 |
| E | 7.620 | 9.398 | 0.300 | 0.370 |
| e | 2.286 | 2.794 | 0.090 | 0.110 |
| E1 | 11.176 | 12.954 | 0.440 | 0.510 |
| F | 2.616 | 2.870 | 0.103 | 0.113 |
| L1 | 17.526 | 18.542 | 0.690 | 0.730 |
| L2 | 7.544 | 8.636 | 0.297 | 0.340 |
| M | 3.708 | 3.962 | 0.146 | 0.156 |

3-Lead TO-220 Plastic Package



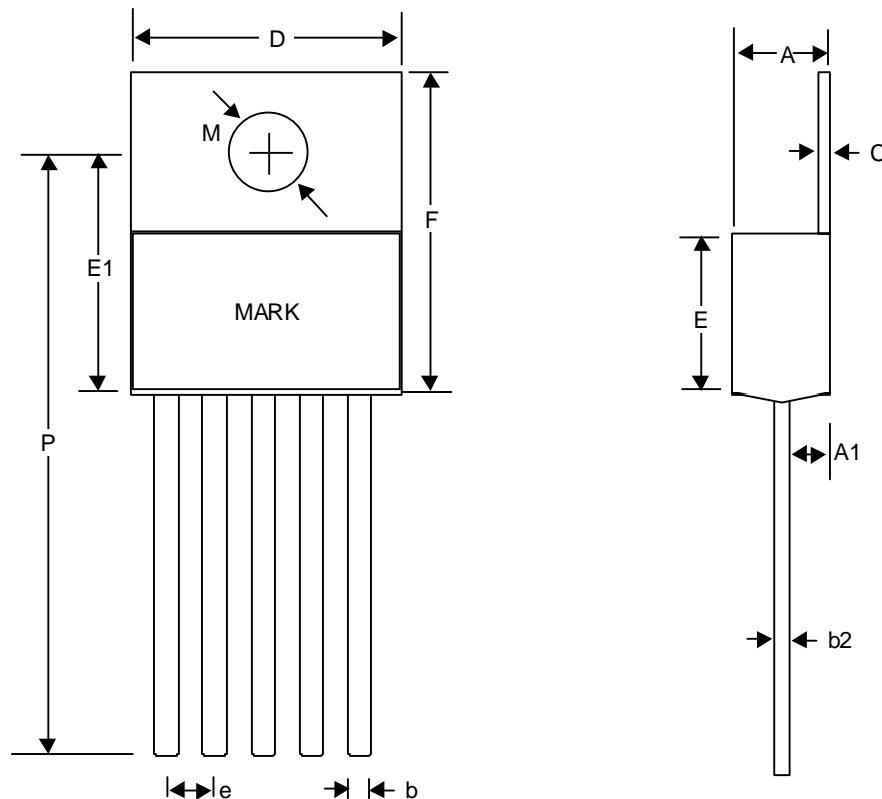
| Symbol | Dimensions In Millimeters | | Dimensions In Inches | |
|--------|---------------------------|--------|----------------------|-------|
| | Min | Max | Min | Max |
| A | 4.064 | 4.826 | 0.160 | 0.190 |
| B | 1.143 | 1.676 | 0.045 | 0.066 |
| b | 0.660 | 0.914 | 0.026 | 0.036 |
| b1 | 1.143 | 1.397 | 0.045 | 0.055 |
| b2 | 0.305 | 0.584 | 0.012 | 0.023 |
| C | 1.143 | 1.397 | 0.045 | 0.055 |
| D | 9.652 | 10.668 | 0.380 | 0.420 |
| E | 8.128 | 9.652 | 0.320 | 0.380 |
| e | 2.286 | 2.794 | 0.090 | 0.110 |
| L1 | 14.605 | 15.875 | 0.575 | 0.625 |
| L2 | 2.286 | 2.794 | 0.090 | 0.110 |
| U | 6.223 Ref. | | 0.245 Ref. | |
| V | 7.620 Ref. | | 0.300 Ref. | |

3-Lead TO- 263 Surface Mount



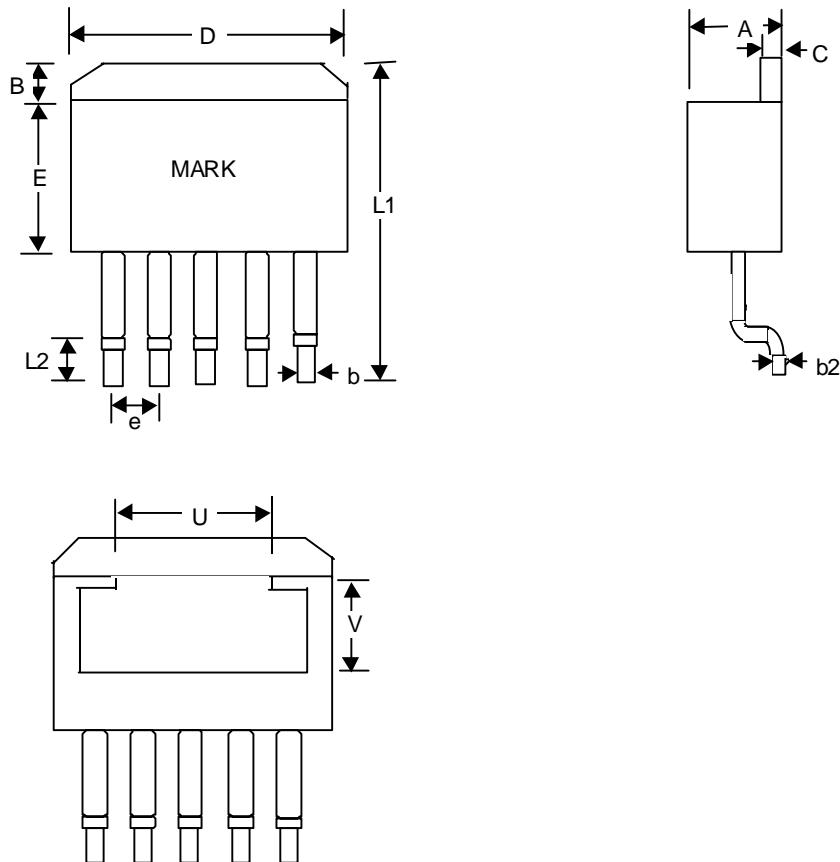
| Symbol | Dimensions In Millimeters | | Dimensions In Inches | |
|--------|---------------------------|-------|----------------------|--------|
| | Min | Max | Min | Max |
| A | -- | 1.803 | -- | 0.071 |
| A1 | 0.020 | 0.100 | 0.0008 | 0.0047 |
| b | 0.610 | 0.787 | 0.024 | 0.031 |
| B | 3.302 | 3.708 | 0.130 | 0.146 |
| C | 6.706 | 7.290 | 0.264 | 0.287 |
| D | 6.299 | 6.706 | 0.248 | 0.264 |
| D1 | 2.896 | 3.150 | 0.114 | 0.124 |
| e | 2.261 | 2.362 | 0.089 | 0.093 |
| H | 0.229 | 0.330 | 0.009 | 0.013 |
| L | 0.914 | -- | 0.036 | -- |

3-Lead SOT-223 Plastic Surface Mount



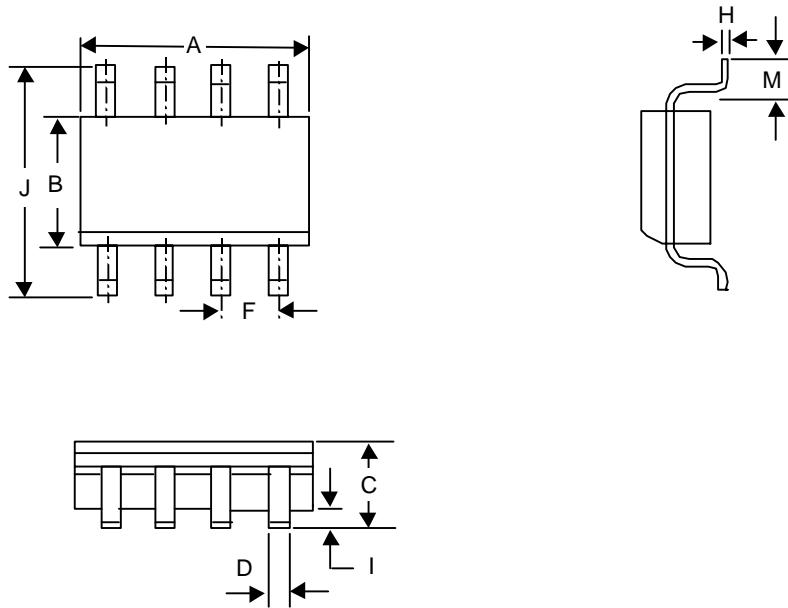
| Symbol | Dimensions In Millimeters | | Dimensions In Inches | |
|--------|---------------------------|--------|----------------------|-------|
| | Min | Max | Min | Max |
| A | 4.064 | 4.826 | 0.160 | 0.190 |
| A1 | 2.032 | 2.921 | 0.080 | 0.115 |
| b | 0.635 | 1.016 | 0.025 | 0.040 |
| b2 | 0.305 | 0.559 | 0.012 | 0.022 |
| C | 1.143 | 1.397 | 0.045 | 0.055 |
| c | 1.524 | 1.829 | 0.060 | 0.072 |
| D | 9.779 | 10.668 | 0.385 | 0.420 |
| E | 7.620 | 9.398 | 0.300 | 0.370 |
| E1 | 11.176 | 12.954 | 0.440 | 0.510 |
| F | 14.224 | 15.113 | 0.560 | 0.595 |
| M | 3.708 | 3.962 | 0.146 | 0.156 |
| P | 24.689 | 26.416 | 0.972 | 1.040 |

5-Lead TO-220 Plastic Package



| Symbol | Dimensions In Millimeters | | Dimensions In Inches | |
|--------|---------------------------|--------|----------------------|-------|
| | Min | Max | Min | Max |
| A | 4.064 | 4.826 | 0.160 | 0.190 |
| B | 1.143 | 1.676 | 0.045 | 0.066 |
| b | 0.660 | 0.914 | 0.026 | 0.036 |
| b2 | 0.305 | 0.584 | 0.012 | 0.023 |
| C | 1.143 | 1.397 | 0.045 | 0.055 |
| D | 9.652 | 10.668 | 0.380 | 0.420 |
| E | 8.128 | 9.652 | 0.320 | 0.380 |
| e | 1.524 | 1.829 | 0.060 | 0.072 |
| L1 | 14.605 | 15.875 | 0.575 | 0.625 |
| L2 | 2.286 | 2.794 | 0.090 | 0.110 |
| U | 6.223 Ref. | | 0.245 Ref. | |
| V | 7.620 Ref. | | 0.300 Ref. | |

5-Lead TO-263 Plastic Surface Mount Package



| Symbol | Dimensions In Millimeters | | Dimensions In Inches | |
|--------|---------------------------|-------|----------------------|-------|
| | Min | Max | Min | Max |
| A | 4.801 | 5.004 | 0.189 | 0.197 |
| B | 3.810 | 3.988 | 0.150 | 0.157 |
| C | 1.346 | 1.753 | 0.053 | 0.069 |
| D | 0.330 | 0.508 | 0.013 | 0.020 |
| F | 1.194 | 1.346 | 0.047 | 0.053 |
| H | 0.178 | 0.254 | 0.007 | 0.010 |
| I | 0.102 | 0.254 | 0.004 | 0.010 |
| J | 5.791 | 6.198 | 0.228 | 0.244 |
| M | 0.406 | 1.270 | 0.016 | 0.050 |

8-Lead SOP Plastic Package

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